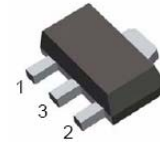
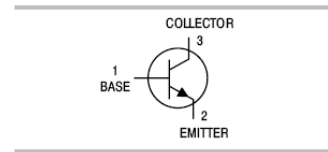


## NPN Silicon AF Transistors

## BCX54/BCX55/BCX56

### FEATURES

- For AF driver and output stages
- High collector current
- Low collector-emitter saturation voltage
- Complementary types:BCX51...BCX53(PNP)



**SOT-89**

### ORDERING INFORMATION

Type No.	Marking	Package Code
BCX54	BA	SOT-89
BCX54-10	BC	SOT-89
BCX54-16	BD	SOT-89
BCX55	BE	SOT-89
BCX55-10	BG	SOT-89
BCX55-16	BM	SOT-89
BCX56	BH	SOT-89
BCX56-10	BK	SOT-89
BCX56-16	BL	SOT-89

### MAXIMUM RATING @ Ta=25°C unless otherwise specified

Symbol	Parameter	Value	Unit
$V_{CBO}$	Collector-Base Voltage	BCX54	45
		BCX55	60
		BCX56	100
$V_{CEO}$	Collector-Emitter Voltage	BCX54	45
		BCX55	60
		BCX56	80
$V_{EBO}$	Emitter-Base Voltage	5	V
$I_C$	DC Collector Current	1	A
$I_{CM}$	Peak Collector Current	1.5	A
$I_B$	Base current	100	mA
$I_{BM}$	Peak base current	200	mA
$P_{tot}$	Total power dissipation, $T_S=130^\circ\text{C}$	1	W
$T_j, T_{stg}$	Junction and Storage Temperature	-65 to +150	$^\circ\text{C}$

## NPN Silicon AF Transistors

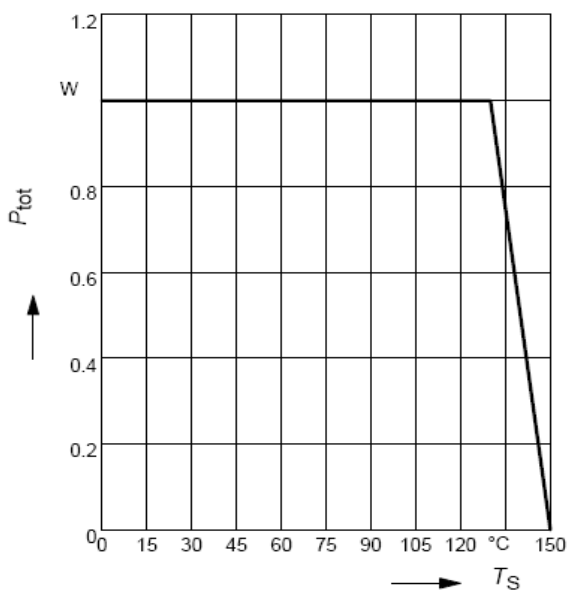
## BCX54/BCX55/BCX56

ELECTRICAL CHARACTERISTICS @  $T_a=25^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Test conditions	MIN	MAX	UNIT
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C=100\mu\text{A}$ $I_B=0$ BCX54 BCX55 BCX56	45 60 100		V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C=10\text{mA}$ $I_B=0$ BCX54 BCX55 BCX56	45 60 80		V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=10\mu\text{A}$ $I_C=0$	5		V
Collector cut-off current	$I_{CBO}$	$V_{CB}=30\text{V}$ $I_E=0$		100	nA
		$V_{CB}=30\text{V}$ $I_E=0$ , $T_A=150^\circ\text{C}$		20	$\mu\text{A}$
DC current gain	$h_{FE}$	$V_{CE}=2\text{V}$ $I_C=5\text{mA}$	25		
		$V_{CE}=2\text{V}$ $I_C=150\text{mA}$	40	250	
		$V_{CE}=2\text{V}$ $I_C=500\text{mA}$	25		
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=500\text{mA}$ $I_B=50\text{mA}$		0.5	V
Base-emitter voltage	$V_{BE}$	$I_C=500\text{mA}$ , $V_{CE}=2\text{V}$		1	V
Transition frequency	$f_T$	$V_{CE}=10\text{V}$ , $I_C=50\text{mA}$ , $f=20\text{MHz}$	100		MHz

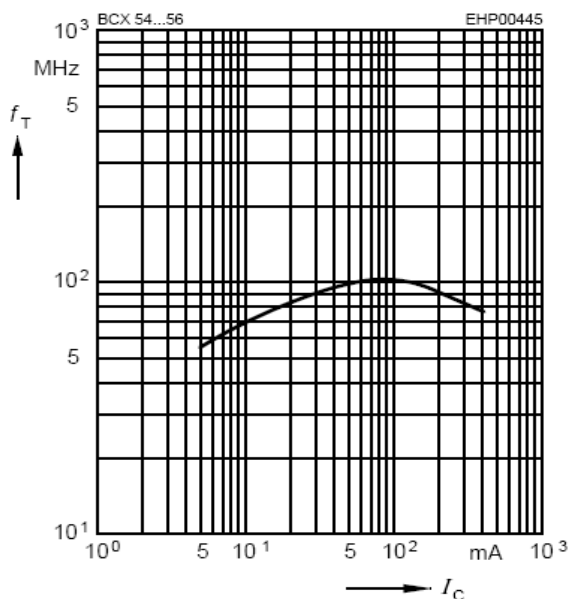
TYPICAL CHARACTERISTICS @  $T_a=25^\circ\text{C}$  unless otherwise specified

Total power dissipation  $P_{tot} = f(T_S)$



Transition frequency  $f_T = f(I_C)$

$V_{CE} = 10\text{V}$

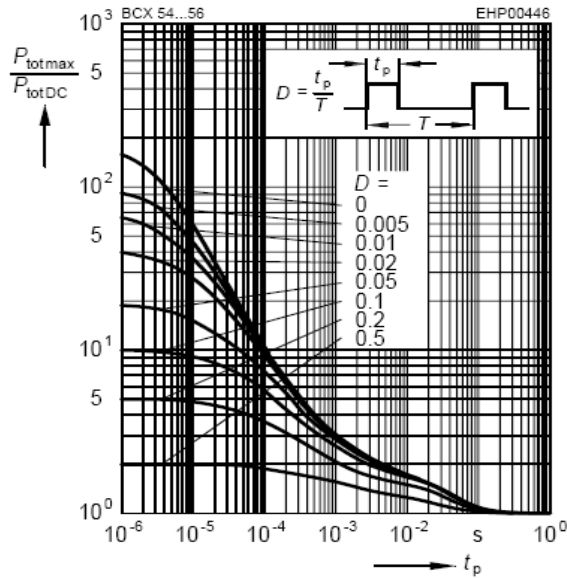


## NPN Silicon AF Transistors

## BCX54/BCX55/BCX56

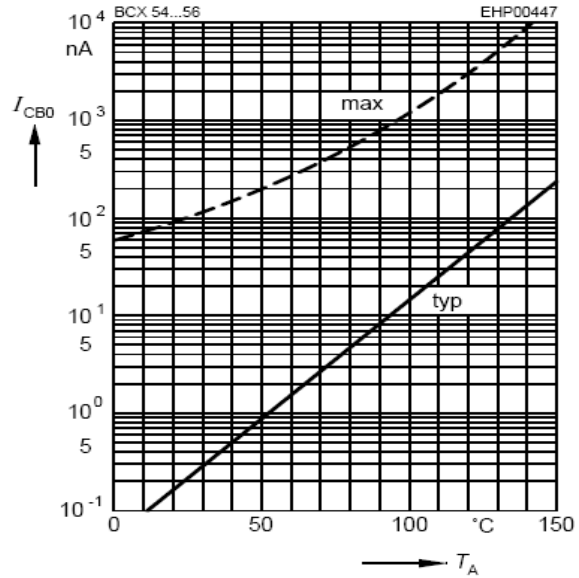
### Permissible pulse load

$$P_{\text{totmax}} / P_{\text{totDC}} = f(t_p)$$



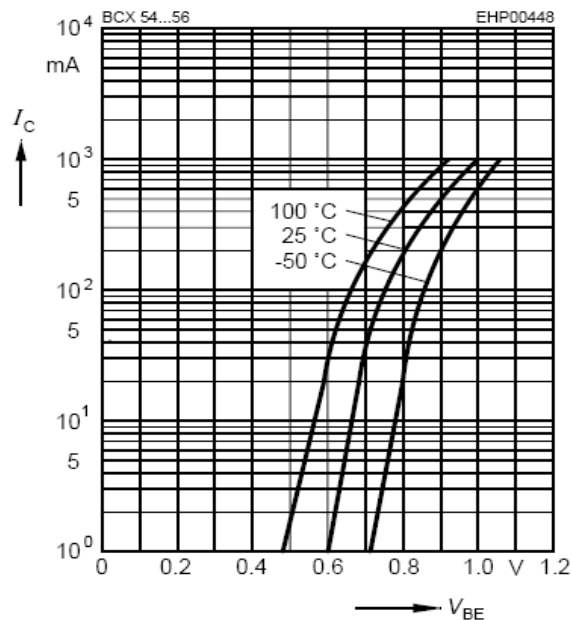
### Collector cutoff current $I_{\text{CBO}} = f(T_A)$

$$V_{\text{CB}} = 30\text{V}$$



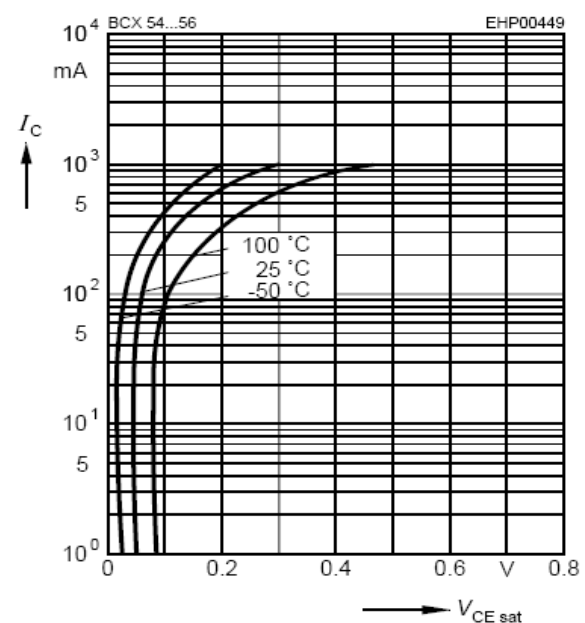
### Collector current $I_C = f(V_{\text{BE}})$

$$V_{\text{CE}} = 2\text{V}$$



### Collector-emitter saturation voltage

$$I_C = f(V_{\text{CEsat}}), h_{\text{FE}} = 10$$



# NPN Silicon AF Transistors

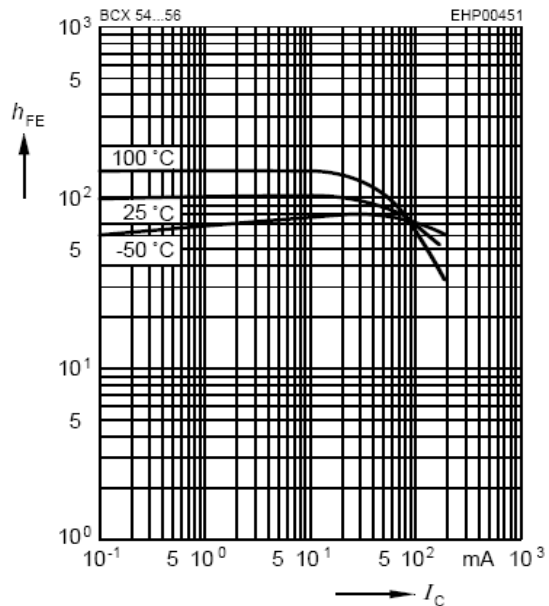
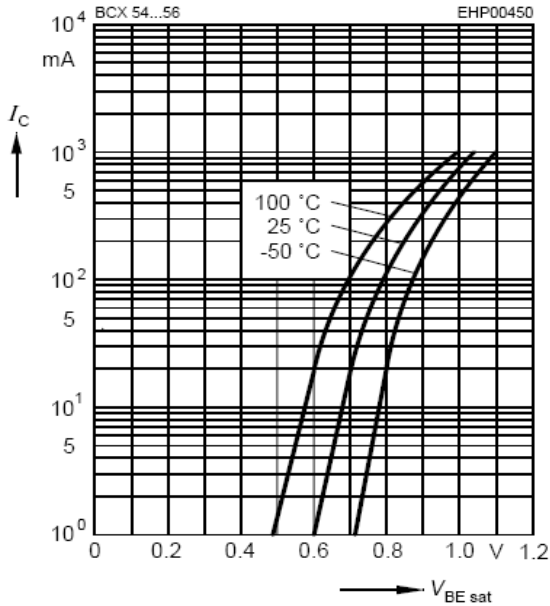
# BCX54/BCX55/BCX56

### Base-emitter saturation voltage

$$I_C = f(V_{BEsat}), h_{FE} = 10$$

### DC current gain $h_{FE} = f(I_C)$

$$V_{CE} = 2V$$



## PACKAGE OUTLINE

Plastic surface mounted package

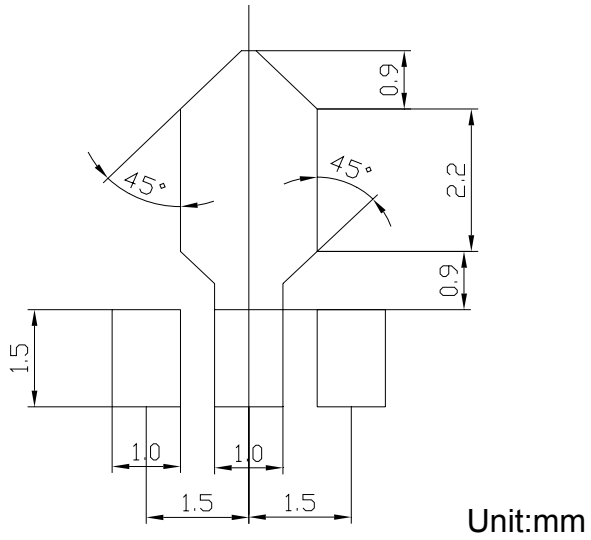
SOT-89

SOT-89		
Dim	Min	Max
A	4.5	4.7
B	2.3	2.7
C	1.5Typical	
D	0.35	0.55
E	1.4	1.6
F	0.4	0.6
H	1.55	1.75
J	0.4Typical	
K	4.15	4.25
All Dimensions in mm		

## NPN Silicon AF Transistors

## BCX54/BCX55/BCX56

### SOLDERING FOOTPRINT



### PACKAGE INFORMATION

Device	Package	Shipping
BCX54/BCX55/BCX56	SOT-89	1000/Tape&Reel